

NOTES:
MATERIAL:

- 1. HOUSING MATERIAL : GLASS FILLED POLYESTER UL94V-0.
- 2. CONTACT MATERIAL : PHOSPHOR BRONZE t=0.30mm.
- 3. PLATING : SELECTING GOLD PLATING 1u"~50u" OVER NICKEL IN CONTACT AREA. 150u" TIN PLATING OVER NICKEL IN SOLDER AREA
- 4. SHIELD : 0.20mm THICKNESS COPPER ALLY WITH NICKEL PLATE!

ELECTRICAL:

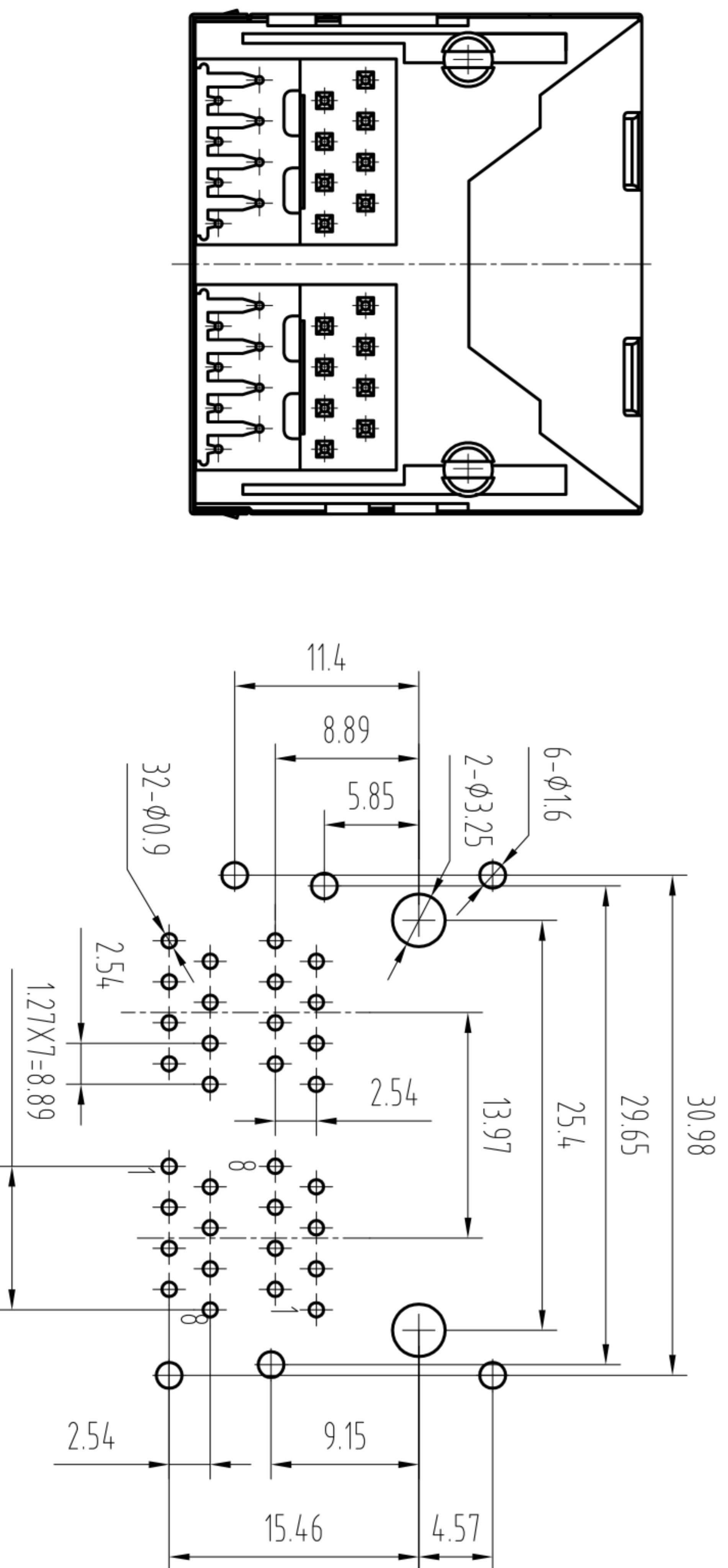
- 1. VOLTAGE RATING : 125 VAC RMS.
- 2. CURRENT RATING : 1.5 AMP.
- 3. CONTACT RESISTANCE : 30 MILLIOHMS MAX.
- 4. INSULATION RESISTANCE : 500 MEGOHMS MIN @ 500V DC .
- 5. DIELECTRIC WITHSTANDING RESISTANCE

MECHANICAL:

- 1. DURRABILITY : 750 CYCLES MIN.
- 2. PCB RETENTION PRE-SOLDER : 1 LB MIN.

ENVIRONMENTAL:

- 1. STORAGE : -40° C TO 85° C.
- 2. OPERATION : 0° C TO 70° C.



PC Board Layout
Component Side Shown

ECN NO.	REV.	DATE.	DESCRIPTION.	CHANGE.	CHECK.	APPRO.
	A		NEW			

APPROVALS		DATE	<p>深圳市联丰电子有限公司 SHENZHEN LINPENYING ELECTRONIC CO.,LTD</p>
DRAWN	ZHIWEI.CHEN	2015.07.07	
CHECKED			
APPROVALS			TITLE:
TOLERANCES ARE	30~以上 ±0.30	ANGLE	PART NO. RJ45-6W22-DDYG-AB-88-B1
	10~30 ±0.20		SCALE: 1:1
	5~10 ±0.15		PROJ:
	~ 5 ±0.10	±2°	DRAWING NO.
			SHEET 1 OF 1